

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Young Ghyu AHN</td> <td>07/25/2012</td> </tr> <tr> <td>Byoung Hwa LEE</td> <td>07/25/2012</td> </tr> <tr> <td>Min Cheol PARK</td> <td>07/25/2012</td> </tr> <tr> <td>Sang Soo PARK</td> <td>07/25/2012</td> </tr> <tr> <td>Dong Seok PARK</td> <td>07/25/2012</td> </tr> </tbody> </table>	Name	Execution Date	Young Ghyu AHN	07/25/2012	Byoung Hwa LEE	07/25/2012	Min Cheol PARK	07/25/2012	Sang Soo PARK	07/25/2012	Dong Seok PARK	07/25/2012	
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Min Cheol PARK	07/25/2012												
Sang Soo PARK	07/25/2012												
Dong Seok PARK	07/25/2012												
RECEIVING PARTY DATA													
Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.												
Street Address:	314 Maetan 3-Dong, Yeongtong-Gu												
City:	Suwon, Gyunggi-Do												
State/Country:	KOREA, REPUBLIC OF												
Postal Code:	443-743												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13590270</td> </tr> </tbody> </table>	Property Type	Number	Application Number:	13590270									
Property Type	Number												
Application Number:	13590270												
CORRESPONDENCE DATA													
Fax Number:	2027568087												
Phone:	202-756-8608												
Email:	mweipdocket@mwe.com												
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>													
Correspondent Name:	MCDERMOTT WILL & EMERY LLP												
Address Line 1:	600 13th Street, N.W.												
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20005-3096												
ATTORNEY DOCKET NUMBER:	085946-0256												
NAME OF SUBMITTER:	Stephen A. Becker												
Total Attachments: 3 source=Assignment_085946-0256#page1.tif source=Assignment_085946-0256#page2.tif source=Assignment_085946-0256#page3.tif													

CH \$40.00 13590270

RECORDATION FORM COVER SHEET

PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Young Ghyu AHN (07/25/2012), Byoung Hwa LEE  
(07/25/2012), Min Cheol PARK (07/25/2012), Sang Soo  
PARK (07/25/2012), and Dong Seok PARK  
(07/25/2012)

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

SAMSUNG ELECTRO-MECHANICS  
CO., LTD.

Name: \_\_\_\_\_

Internal Address: \_\_\_\_\_

Street Address: \_\_\_\_\_

314 Maetan 3-dong, Yeongtong-gu

City: \_\_\_\_\_ Suwon

State: \_\_\_\_\_ Gyunggi-do

Country: \_\_\_\_\_ Republic of Korea Zip: \_\_\_\_\_

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): in parentheses after inventor name

☒ Assignment ☐ Merger ☐ Change of Name

☐ Security Agreement ☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other \_\_\_\_\_

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Stephen A. Becker, P.C.  
MCDERMOTT WILL & EMERY LLP

Internal Address: Atty. Dkt.: 085946-0256

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6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

☒ Authorized to be charged to deposit account

☐ Enclosed

☐ None required (government interest not affecting title)

8. Payment Information

Deposit Account Number \_\_\_\_\_ 50-0417

Authorized User Name \_\_\_\_\_ Stephen A. Becker, P.C.

9. Signature:

Signature

August 21, 2012

Date

Stephen A. Becker, P.C. - 26,527

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

(SAB)

Docket No.: \_\_\_\_\_

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>AHN, Young Ghyu</u>	(4) <u>PARK, Sang Soo</u>
(2) <u>LEE, Byoung Hwa</u>	(5) <u>PARK, Dong Seok</u>
(3) <u>PARK, Min Cheol</u>	(6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG Electro-Mechanics Co., Ltd.

314 Maetan 3-Dong, Yeongtong-Gu,

Suwon, Gyunggi-Do

Republic of KOREA

Postal Code: 443-743

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

MOUNTING STRCUTURE OF CIRCUIT BOARD HAVING MULTI-LAYERED CERAMIC  
CAPACITOR THEREON

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_, and identified by United States Serial No. \_\_\_\_\_; or

(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.


SIGNED on the dates indicated aside our signatures:

INVENTORS

DATE SIGNED

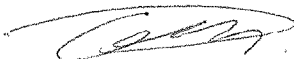
1)  July 25, 2012  
Name: AHN, Young Ghyu

2)  July 25, 2012  
Name: LEE, Byoung Hwa

3)  July 25 2012  
Name: PARK, Min Cheol

PATENT

REEL: 028817 FRAME: 0728

4)  July, 25, 2012  
Name: PARK, Sang Soo

5) Park July 25, 2012  
Name: PARK, Dong Seok